

Search by part #

Part Number - 6399B - P2G RoH5 V Compliant



Printer friendly version

Products



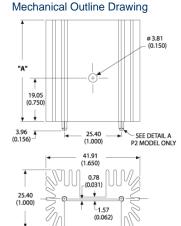
Useful Links

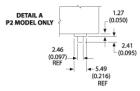
Building a Part #

Catalog Request

How to Urder?_____
 MSDS Safety Sheets.
 Part # Cross Ref_____
 Quote Request_____
 RoHS Initiative_____
 Sample Request_____

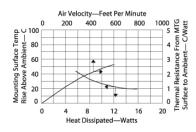
Directions
 Find Distributor
 Find Sales Rep
 How to Order?





A Dim 50.80

Thermal Curves





Thermal resistance value is based on a 75°C rise in natural convection

Product Information

Part #	Description	Finish	Board Mounting
6399B - P2G	High power extruded Heatsink with large radial fins and solderable shoulder pins	Black Anodize	View Hole Dimensions
normal sold The heat re	electronic component is functionally u lering or reflow processes used for se sistance time or heat resistance temp or the component.	miconductor o	circuits.

Not Exactly what you need?

We offer several options for those applications which require a more unique solution. For slight modifications of this part or other attachment options, finishes, and interface materials, contact your local representative . Challenge us with your thermal requirements - we can design custom solutions.